imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

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October 2016

Chip beads

For power line

MPZ series

MPZ1608 Type

MPZ1608

1608[0603 inch]*

* Dimensions code Dimensions code JIS[EIA]

Reminders for using these products

Before using these products, be sure to request the delivery specifications.

Safety reminders

Please pay sufficient attention to the warnings for safe designing when using this products.

⚠ Reminders							
 The storage period is less than 12 months. Be sure to follow the st less). 	orage conditions (temperature:5 to 40°C, humidity:10 to 75% RH or						
If the storage period elapses, the soldering of the terminal electrodes may deteriorate.							
\bigcirc Do not use or store in locations where there are conditions such as	s gas corrosion (salt, acid, alkali, etc.).						
 Before soldering, be sure to preheat components. The preheating temperature should be set so that the temperature does not exceed 150°C. 	re difference between the solder temperature and chip temperature						
 Soldering corrections after mounting should be within the range of If overheated, a short circuit, performance deterioration, or lifespar 	-						
When embedding a printed circuit board where a chip is mounted the overall distortion of the printed circuit board and partial distortion							
Self heating (temperature increase) occurs when the power is tu design.	Irned ON, so the tolerance should be sufficient for the set thermal						
 Carefully lay out the coil for the circuit board design of the non-may A malfunction may occur due to magnetic interference. 	gnetic shield type.						
\bigcirc Use a wrist band to discharge static electricity in your body throug	h the grounding wire.						
\bigcirc Do not expose the products to magnets or magnetic fields.							
\bigcirc Do not use for a purpose outside of the contents regulated in the c	lelivery specifications.						
ment, industrial robots) under a normal operation and use condition The products are not designed or warranted to meet the requirement ity require a more stringent level of safety or reliability, or whose far person or property.	ment, personal equipment, office equipment, measurement equip-						
 (1) Aerospace/aviation equipment (2) Transportation equipment (cars, electric trains, ships, etc.) (3) Medical equipment (4) Power-generation control equipment (5) Atomic energy-related equipment (6) Seabed equipment (7) Transportation control equipment 	 (8) Public information-processing equipment (9) Military equipment (10) Electric heating apparatus, burning equipment (11) Disaster prevention/crime prevention equipment (12) Safety equipment (13) Other applications that are not considered general-purpose applications 						
When designing your equipment even for general-purpose application tection circuit/device or providing backup circuits in your equipment.	ns, you are kindly requested to take into consideration securing pro-						

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Chip beads

For power line

Overview of MPZ1608 type

FEATURES

- Noise reduction solution for power line.
- O Compared to the MMZ series, has low direct current resistance for compatibility with large currents, optimal for low power consumption.
- O Various frequency characteristics with 5 materials of different features for countermeasures against everything from general signals to high-speed signals.
- O Performs well even in signal lines where low direct current resistance is required.

APPLICATION

- O Noise removal for mobile devices such as smartphones and tablet terminals, and various modules.
- O Noise removal for PCs and recorders, household appliances such as STBs, smart grids, and industrial equipment.

PART NUMBER CONSTRUCTION

MPZ	-	1608	В	4	71	A	L .		Т	A00)
Series name	L×W× ⁻	Γ dimensions (mm)	Material name	•	dance 100MHz	Characte typ		Pack	aging style	Internal o	ode
	1608	1.6×0.8x0.6	S	260	26	A		Т	Taping	A00	
	1000	1.6×0.8x0.8	Y	471	470	В				AH0	
			В								
			R								
			D								

OPERATING TEMPERATURE RANGE, PACKAGE QUANTITY, PRODUCT WEIGHT

tempe		Temperatu	ure ranges	Package quantity	Individual weight	
		Operating Storage temperature temperature*				
		(° C)	(°C)	(pieces/reel)	(mg)	
MPZ1608	t=0.6mm	-55 to +125	-55 to +125	4,000	3	
t=0.8mm -55 to +125 -55 to +1		-55 to +125	4,000	4		

* The storage temperature range is for after the circuit board is mounted.

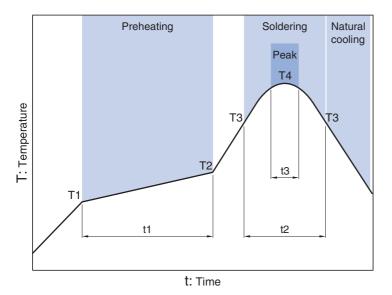
OROHS Directive Compliant Product: See the following for more details.https://product.tdk.com/info/en/environment/rohs/index.html

O Halogen-free: indicates that CI content is less than 900ppm, Br content is less than 900ppm, and that the total CI and Br content is less than 1500ppm.

Please be sure to request delivery specifications that provide further details on the features and specifications of the products for proper and safe use. Please note that the contents may change without any prior notice due to reasons such as upgrading.

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RECOMMENDED REFLOW PROFILE



Preheatin	g		Soldering		Peak	
Temp.		Time	Temp.	Time	Temp.	Time
T1	T2	t1	Т3	t2	Τ4	t3
150°C	180°C	60 to 120s	230°C	30 to 60s	250 to 260°C	10s

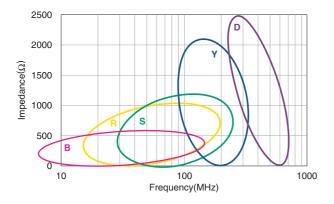
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MATERIAL CHARACTERISTIC

- B material: This type is perfectly suited for fast digital signals. By equalizing R components and X components that beads possess at a frequency of 5MHz, it is able to suppress overshooting, undershooting and ringing of fast digital signals.
- R material: For wide frequency applications calling for broad impedance characteristics. For digital signal line applications calling requiring good waveform integrity. Impedance values selected for effectiveness at 10 to 200MHz.
- S material: Standard type that features impedance characteristics similar to those of a typical ferrite core. For signal line applications in which the blocking region is near 100MHz. Impedance values selected for effectiveness at 40 to 300MHz.
- Y material: High frequency range type intended for the 100MHz region and above. For signal line applications in which the signal frequency is far from the cutoff frequency. Impedance values selected for effectiveness at 80 to 400MHz.
- D material: For applications calling for low insertion loss at low frequencies and sharply increasing impedance at high frequencies. Designed for high impedance at high frequencies (300MHz to 1GHz) for signal line applications.

TYPICAL MATERIAL IMPEDANCE CHARACTERISTICS



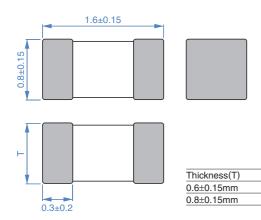
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(6/11)

MPZ1608 type

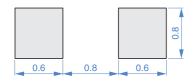
SHAPE & DIMENSIONS





Dimensions in mm

RECOMMENDED LAND PATTERN



Dimensions in mm

ELECTRICAL CHARACTERISTICS

CHARACTERISTICS SPECIFICATION TABLE

	DC resistance	Rated current*	Thickness T	Part No.
Tolerance	(Ω)max.	(A)max.	(mm)	
±25%	0.150	1.0	0.8	MPZ1608B471ATA00
±25%	0.007	6.0	0.6	MPZ1608S260ATAH0
±10Ω	0.010	5.0	0.6	MPZ1608S300ATAH0
±25%	0.020	3.5	0.6	MPZ1608S600ATAH0
±25%	0.030	3.0	0.6	MPZ1608S101ATAH0
±25%	0.045	2.0	0.6	MPZ1608S121ATAH0
±25%	0.050	2.0	0.6	MPZ1608S181ATAH0
±25%	0.050	2.2	0.8	MPZ1608S221ATA00
±25%	0.080	1.7	0.8	MPZ1608S331ATA00
±25%	0.150	1.0	0.8	MPZ1608S471ATA00
±25%	0.150	1.0	0.8	MPZ1608S601ATA00
±25%	0.300	0.8	0.8	MPZ1608S102ATA00
±25%	0.120	1.2	0.8	MPZ1608R391ATA00
±25%	0.030	2.3	0.8	MPZ1608Y600BTA00
±25%	0.040	2.0	0.8	MPZ1608Y101BTA00
±25%	0.050	1.8	0.8	MPZ1608Y151BTA00
±25%	0.100	1.5	0.8	MPZ1608Y221BTA00
±10Ω	0.060	1.8	0.8	MPZ1608D300BTA00
±25%	0.100	1.2	0.8	MPZ1608D600BTA00
±25%	0.150	1.0	0.8	MPZ1608D101BTA00
	±25% ±25%	Tolerance(Ω)max. $\pm 25\%$ 0.150 $\pm 25\%$ 0.007 $\pm 10\Omega$ 0.010 $\pm 25\%$ 0.020 $\pm 25\%$ 0.030 $\pm 25\%$ 0.045 $\pm 25\%$ 0.050 $\pm 25\%$ 0.050 $\pm 25\%$ 0.150 $\pm 25\%$ 0.150 $\pm 25\%$ 0.300 $\pm 25\%$ 0.300 $\pm 25\%$ 0.150 $\pm 25\%$ 0.300 $\pm 25\%$ 0.120 $\pm 25\%$ 0.030 $\pm 25\%$ 0.040 $\pm 25\%$ 0.050 $\pm 25\%$ 0.100 $\pm 25\%$ 0.100 $\pm 25\%$ 0.100 $\pm 25\%$ 0.100	Tolerance(Ω)max.(A)max. $\pm 25\%$ 0.1501.0 $\pm 25\%$ 0.0076.0 $\pm 10\Omega$ 0.0105.0 $\pm 25\%$ 0.0203.5 $\pm 25\%$ 0.0303.0 $\pm 25\%$ 0.0452.0 $\pm 25\%$ 0.0502.0 $\pm 25\%$ 0.0801.7 $\pm 25\%$ 0.1501.0 $\pm 25\%$ 0.1501.0 $\pm 25\%$ 0.3000.8 $\pm 25\%$ 0.3002.3 $\pm 25\%$ 0.0402.0 $\pm 25\%$ 0.0501.8 $\pm 25\%$ 0.1001.5 $\pm 10\Omega$ 0.0601.8 $\pm 25\%$ 0.1001.2	Tolerance(Ω)max.(A)max.(mm) $\pm 25\%$ 0.1501.00.8 $\pm 25\%$ 0.0076.00.6 $\pm 10\Omega$ 0.0105.00.6 $\pm 25\%$ 0.0203.50.6 $\pm 25\%$ 0.0303.00.6 $\pm 25\%$ 0.0303.00.6 $\pm 25\%$ 0.0502.00.6 $\pm 25\%$ 0.0502.20.8 $\pm 25\%$ 0.1501.00.8 $\pm 25\%$ 0.1501.00.8 $\pm 25\%$ 0.1501.00.8 $\pm 25\%$ 0.3000.80.8 $\pm 25\%$ 0.1501.20.8 $\pm 25\%$ 0.0302.30.8 $\pm 25\%$ 0.0402.00.8 $\pm 25\%$ 0.0501.80.8 $\pm 25\%$ 0.1001.50.8 $\pm 25\%$ 0.1001.50.8 $\pm 25\%$ 0.1001.20.8

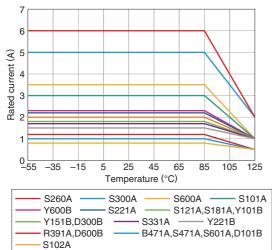
* Please refer to the graph of rated current vs. temperature characteristics (derating) about the rating current at 85°C or more in temperature of the product.

O Measurement equipment

Measurement item	Product No.	Manufacturer
Impedance	E4991A+16192A	Keysight Technologies
DC resistance	Type-7556	Yokogawa

* Equivalent measurement equipment may be used.

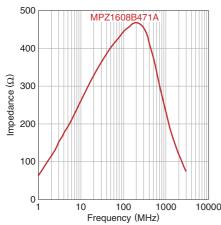
○ Rated current vs. temperature characteristics (derating)

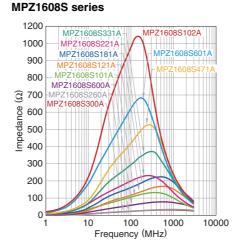


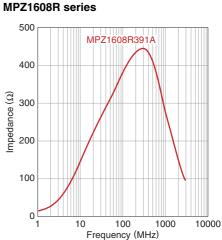
ELECTRICAL CHARACTERISTICS

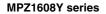
□ Z VS. FREQUENCY CHARACTERISTICS (BY SERIES)

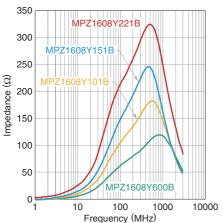
MPZ1608B series



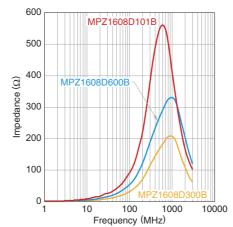








MPZ1608D series



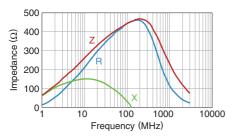
A Please be sure to request delivery specifications that provide further details on the features and specifications of the products for proper and safe use. Please note that the contents may change without any prior notice due to reasons such as upgrading.

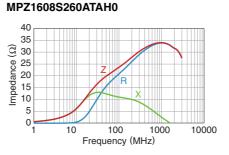
*****<u>⊗</u>TDK*

ELECTRICAL CHARACTERISTICS

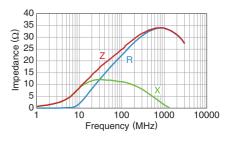
Z, X, R VS. FREQUENCY CHARACTERISTICS

MPZ1608B471ATA00

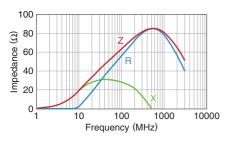




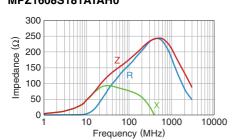
MPZ1608S300ATAH0



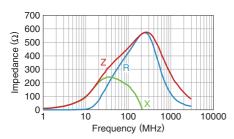
MPZ1608S600ATAH0



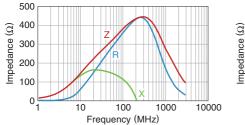
MPZ1608S181ATAH0



MPZ1608S471ATA00



MPZ1608R391ATA00



10

MPZ1608S101ATAH0

160

140

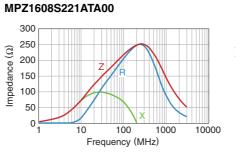
100 Impedance

80

60 40

20

୍ତି 120

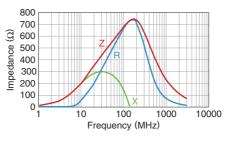


100

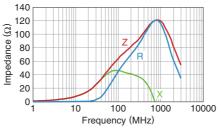
Frequency (MHz)

1000

MPZ1608S601ATA00



MPZ1608Y600BTA00



Impedance 100

MPZ1608S121ATAH0

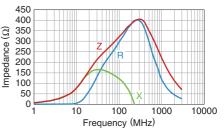
200

୍ତି 150

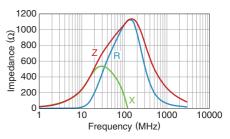
10000

50 0 10000 10 100 1000 Frequency (MHz)

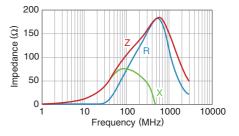
MPZ1608S331ATA00



MPZ1608S102ATA00



MPZ1608Y101BTA00



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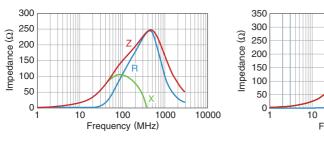
公TDK

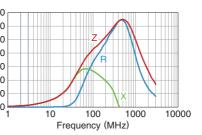
MPZ1608 type

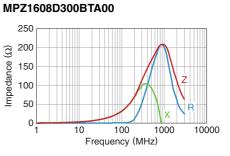
ELECTRICAL CHARACTERISTICS

Z, X, R VS. FREQUENCY CHARACTERISTICS

MPZ1608Y151BTA00



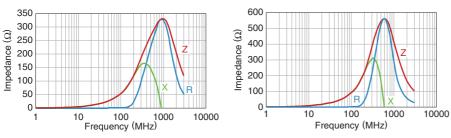




MPZ1608D600BTA00

MPZ1608D101BTA00

MPZ1608Y221BTA00



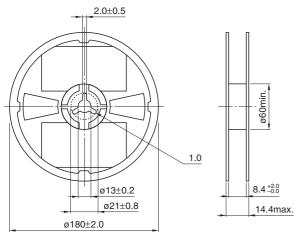
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EMC Components

MPZ1608 type

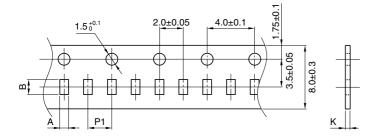
PACKAGING STYLE

REEL DIMENSIONS

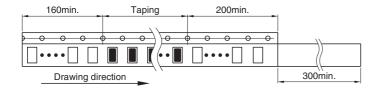


Dimensions in mm

TAPE DIMENSIONS



Dimensions in mi							
Туре	А	В	P1	K			
MPZ1608	1.1±0.2	1.9±0.2	4.0±0.1	1.1max.			



Dimensions in mm